20V N-Channel Trench Power MOSFET

General Description

The SJIA2302 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a wide variety of applications.

Features

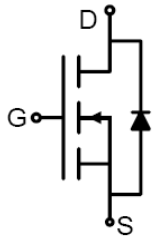
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

Application

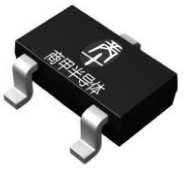
- PWM Applications
- Load Switch
- Power Management

Key Performance Parametes

Parameter	Value	Unit
V_{DS}	20	V
$R_{DS(ON)_TYP}$	46	mΩ
I_D	3.2	A
Q_G	2.5	nC



Schematic Diagram



SOT-323 top view

RoHS

Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJIA2302	2302	SOT-323	Tape	\	\	3000 Pcs

Table 1. Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage (V_{GS}=0V)	20	V
V_{GS}	Gate-Source Voltage (V_{DS}=0V)	±12	V
I_D	Drain Current-Continuous(T_A=25℃)	3.2	A
	Drain Current-Continuous(T_A=100℃)	2	A
$I_{DM\ (pluse)}$	Drain Current-Continuous@ Current-Pulsed (Note 1)	12.8	A
P_D	Maximum Power Dissipation(T_A=25℃)	0.9	W
	Maximum Power Dissipation(T_A=100℃)	0.3	W
E_{AS}	Avalanche energy (Note 2)	5	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	℃

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to- Ambient		145	℃/W

Table 3. Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V I_D=250μA	20			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=20V, V_{GS}=0V T_J=25℃			1	μA
		V_{DS}=20V, V_{GS}=0V T_J=125℃			100	μA
I_{GSS}	Gate-Body Leakage Current	V_{GS}=±12V, V_{DS}=0V			±100	uA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=250μA	0.45		1	V
g_{FS}	Forward Transconductance	V_{DS}=4.5V, I_D=1.5A		6		S
$R_{DS(ON)}$	Drain-Source On-State Resistance	V_{GS}=4.5V, I_D=1.5A T_J=25℃		46	57.5	mΩ
$R_{DS(ON)}$	Drain-Source On-State Resistance	V_{GS}=2.5V, I_D=1A T_J=25℃		59	78.5	mΩ
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS}=10V,V_{GS}=0V, f=1.0MHz		188		pF
C_{oss}	Output Capacitance			27		pF
C_{rss}	Reverse Transfer Capacitance			21		pF
R_g	Gate resistance	V_{GS}=0V, V_{DS}=0V, f=1.0MHz		10		Ω
Switching Parameters						
$t_{d(on)}$	Turn-on Delay Time	V_{GS}=4.5V, V_{DS}=10V, R_L=6.7Ω, R_{GEN}=3Ω		3		nS
t_r	Turn-on Rise Time			11		nS
$t_{d(off)}$	Turn-Off Delay Time			20		nS
t_f	Turn-Off Fall Time			8		nS
Q_g	Total Gate Charge	V_{GS}=4.5V, V_{DS}=10V, I_D=1.5A		2.5		nC
Q_{gs}	Gate-Source Charge			0.5		nC
Q_{gd}	Gate-Drain Charge			0.6		nC
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current (Body Diode)				3.2	A
V_{SD}	Forward on Voltage (Note 3)	V_{GS}=0V, I_S=1.5A			1.2	V
t_{rr}	Reverse Recovery Time	I_F=1.5A, dI/dt=100A/μs		4.3		ns
Q_{rr}	Reverse Recovery Charge	I_F=1.5A, dI/dt=100A/μs		0.6		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.
Notes 2.E_{AS} condition: T_J=25℃,V_{DD}=10V,V_G=10V, Rg=25Ω, L=0.5mH.
Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

Typical Electrical And Thermal Characteristics (Curves)

Figure 1. Output Characteristics

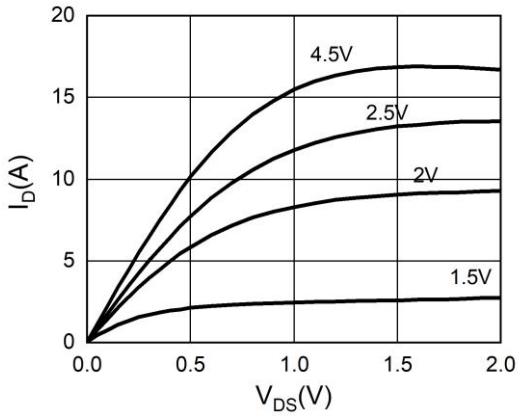


Figure 2. Transfer Characteristics

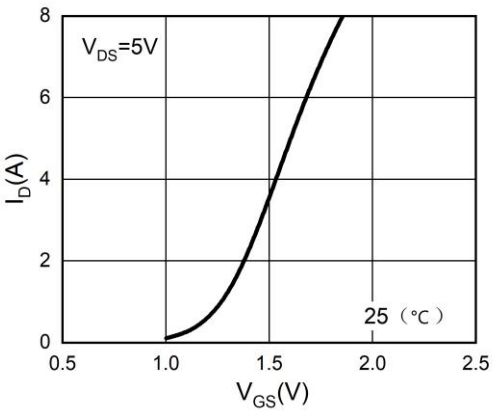


Figure 3. Power Dissipation

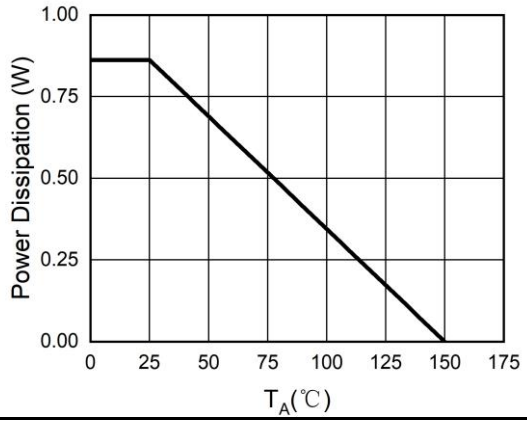


Figure 4. Drain Current

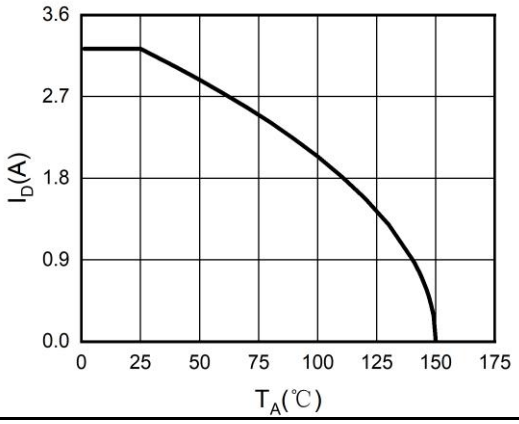


Figure 5. BV_{DSS} vs Junction Temperature

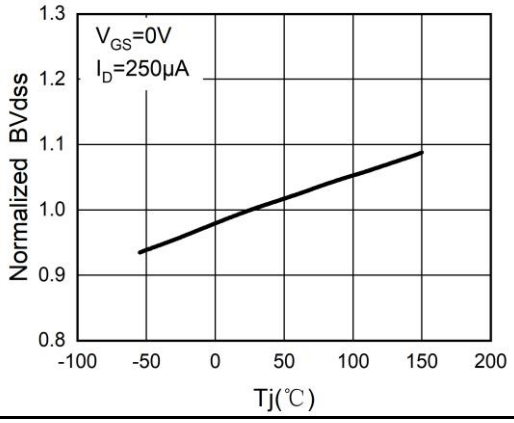
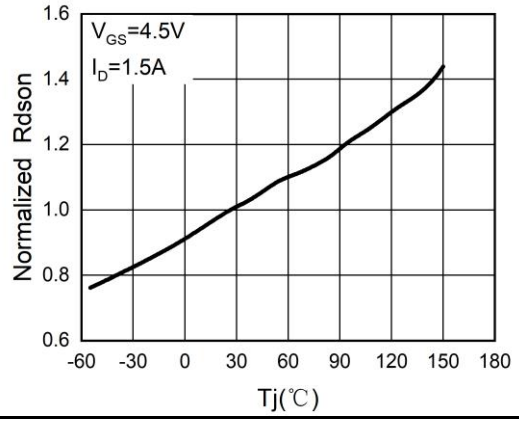


Figure 6. $R_{DS(ON)}$ vs Junction Temperature



Typical Electrical And Thermal Characteristics (Curves)

Figure 7. Gate Charge Waveforms

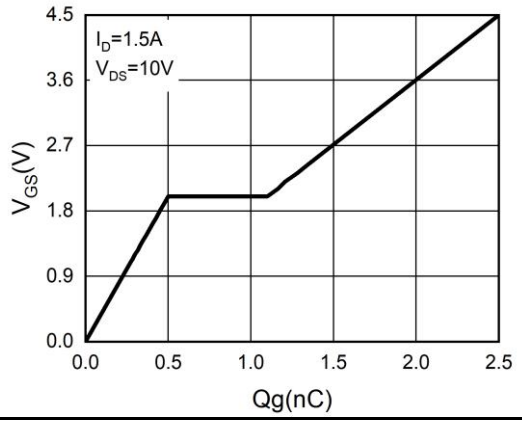


Figure 8. Capacitance

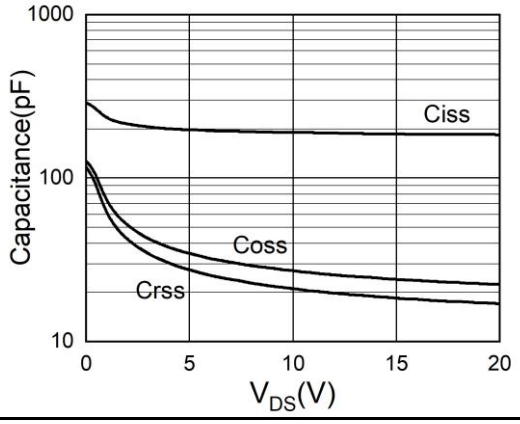


Figure 9. Body-Diode Characteristics

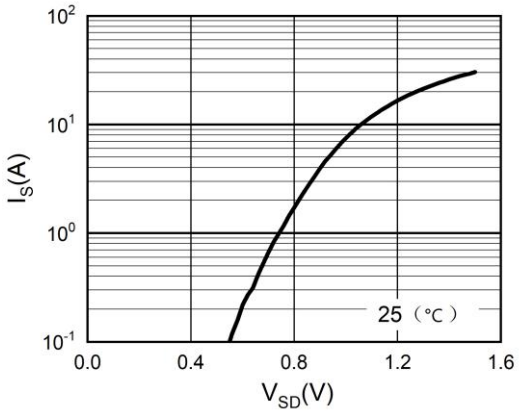
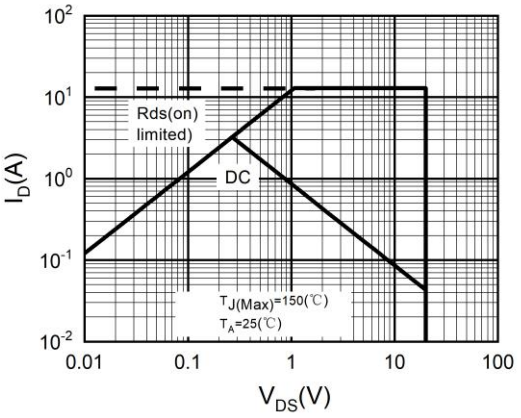
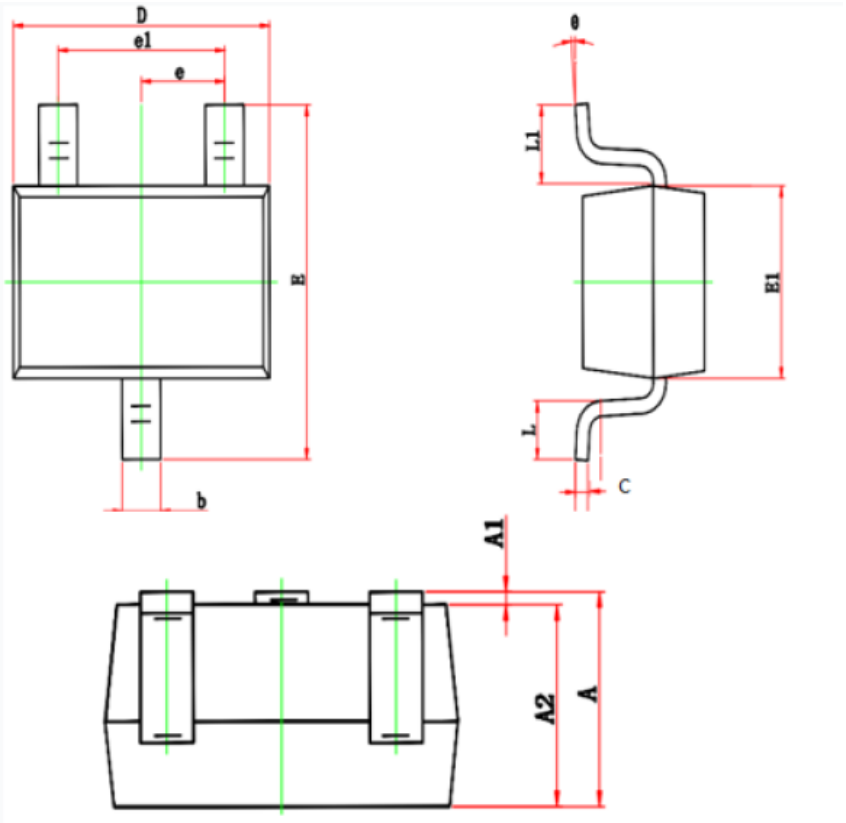


Figure 10. Maximum Safe Operating Area



SOT-323 Package Information



Symbol	Dim in mm		
	最小值	中间值	最大值
A	0.90	1.00	1.10
A1	0.00	0.05	0.10
A2	0.90	0.95	1.00
b	0.15	0.25	0.35
c	0.10	0.12	0.15
D	1.80	2.00	2.20
E	2.15	2.25	2.35
E1	1.15	1.25	1.35
e	0.650TYP.		
e1	1.2	1.3	1.4
L	0.25	0.3	0.4
L1	0.525REF.		
θ	0°	4°	8°

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